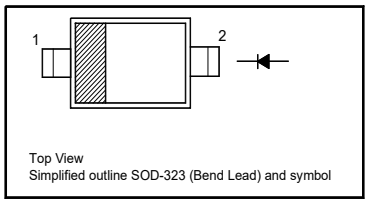
Silicon Epitaxial Planar Switching Diode

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View
Simplified outline SOD-323 (Bend Lead) and symbol

Features

- AEC-Q101 Qualified
- High reliability
- Small plastic package suitable for surface mounted design
- Halogen and Antimony Free(HAF), RoHS compliant

Applications

- High speed switching

Absolute Maximum Ratings (T_a = 25℃)

Parameter	Symbol	Value	Unit
Repetitive Reverse Voltage	V_{RRM}	100	V
Average Rectified Forward Current	$I_{F(AV)}$	200	mA
Non-repetitive Peak Forward Surge Current at t = 1 s at t = 1 μs	I_{FSM}	1 2	A
Power Dissipation [1)]	P_D	200	mW
Junction Temperature	T_j	150	℃
Storage Temperature Range	T_{stg}	- 55 to + 150	℃

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient [1)]	$R_{\theta JA}$	625	℃/W

[1)] Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Dated: 07/08/2026 Rev: 02

Characteristics at T_a = 25℃

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at I_R = 5 μA at I_R = 100 μA	$V_{(BR)R}$	 75 100	 - -	 V V
Forward Voltage at I_F = 10 mA	V_F	-	1	V
Reverse Current at V_R = 20 V at V_R = 75 V at V_R = 20 V, T_j = 150 °C	I_R	 - - -	 25 5 50	 nA μA μA
Total Capacitance at V_R = 0 V, f = 1 MHz	C_{tot}	-	4	pF
Reverse Recovery Time at I_F = 10 mA, I_{rr} = 0.1 × I_R, V_R = 6 V, R_L = 100 Ω	t_{rr}	-	4	ns

Electrical Characteristics Curves

Fig. 1 Power Derating Curve

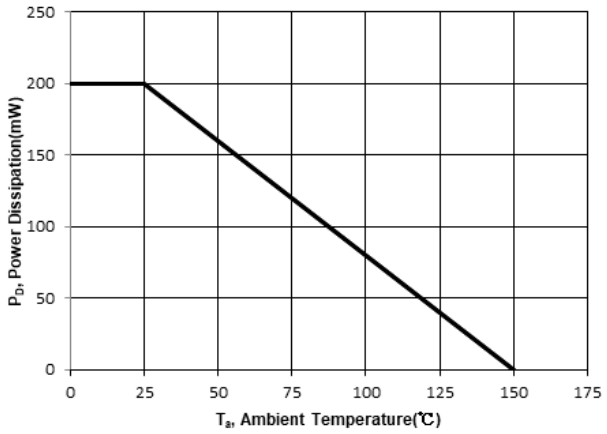


Fig. 2 Capacitance characteristics

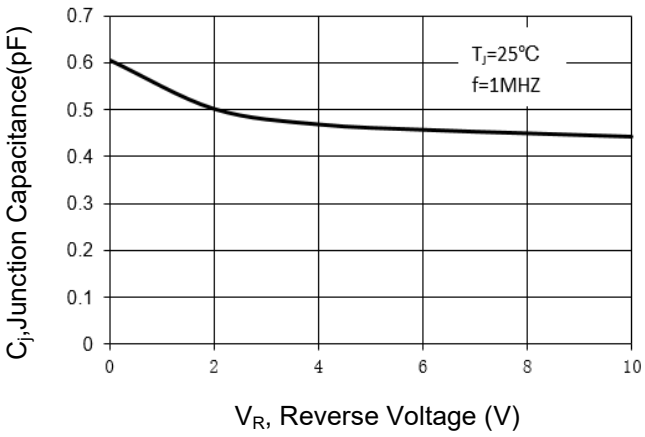


Fig. 3 Reverse Characteristics

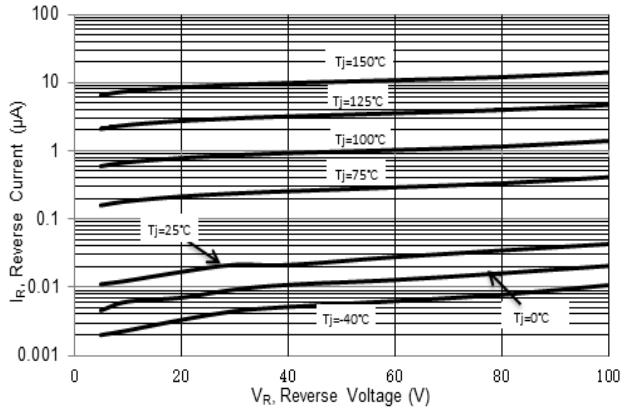
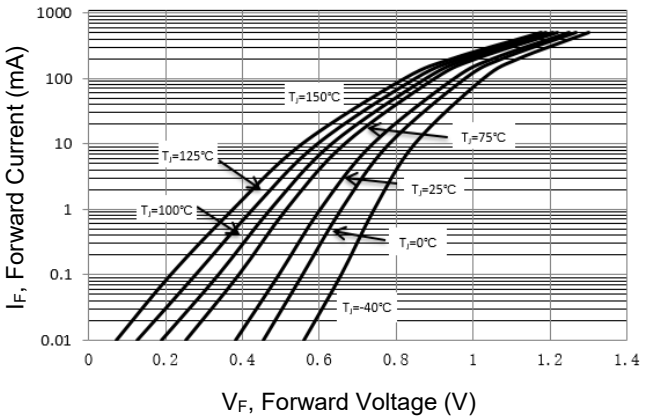
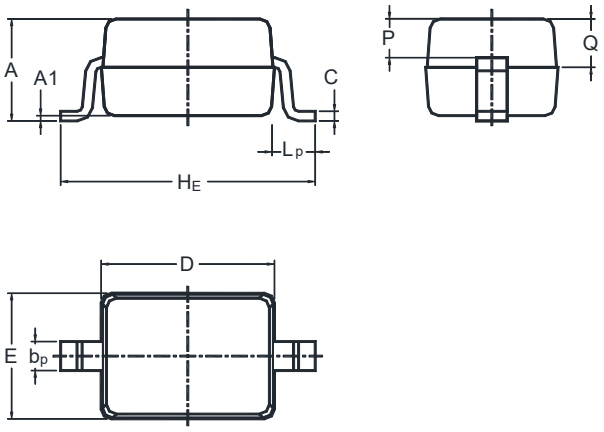


Fig. 4 Forward Characteristics



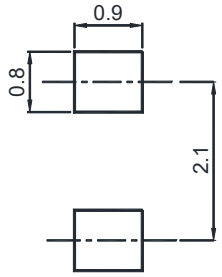
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads **SOD-323BL**



UNIT	A	A_1	b_p	C	D	E	H_E	L_p	Q	P
mm	1.1 0.8	0.1 0	0.4 0.25	0.18 0.09	1.8 1.6	1.35 1.15	2.8 2.3	0.5 0.1	0.5 0.3	0.4 0.3

Recommended Soldering Footprint

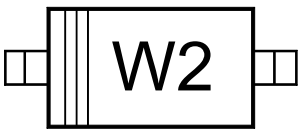


Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOD-323BL	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

Marking information

" W2 " = Part No.
" III " = Cathode line
Font type: Arial



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